

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC4066BP, TC4066BF, TC4066BFT

Quad Bilateral Switch

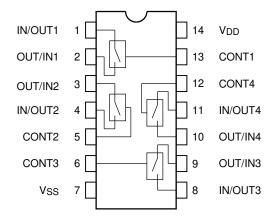
TC4066B contains four independent circuits of bidirectional switches. When control input CONT is set to "H" level, the impedance between input and output of the switch becomes low and when it is set to "L" level, the impedance becomes high. This can be applied for switching of analog signals and digital signals.

ON-resistance, Ron

250 Ω (typ.) : VDD - VSS = 5 V 110 Ω (typ.) : VDD - VSS = 10 V 70 Ω (typ.) : VDD - VSS = 15 V

OFF-resistance, R_{OFF}
 R_{OFF} (typ.) > 10⁹ Ω

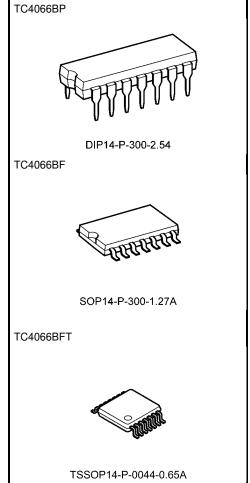
Pin Assignment (top view)



Truth Table

Control	Impedance between IN/OUT-OUT/IN (Note 1)
Н	0.5 to $5 \times 10^2 \Omega$
L	> 10 ⁹ Ω

Note 1: See static electrical characteristics



Weight

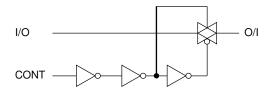
DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.) TSSOP14-P-0044-0.65A : 0.06 g (typ.)

Start of commercial production 1978-09



Logic Diagram

1/4 TC4066B



Absolute Maximum Ratings

Characteristics	Symbol	Rating	Unit
DC supply voltage	V_{DD}	V _{SS} - 0.5 to V _{SS} + 20	V
Control input voltage	V _{CIN}	V _{SS} - 0.5 to V _{DD} + 0.5	٧
Switch I/O voltage	V _I /V _O	V _{SS} - 0.5 to V _{DD} + 0.5	٧
Power dissipation	PD	300 (DIP)/180 (SOP/TSSOP)	mW
Potential difference across I/O during ON	VI - VO	±0.5	V
Control input current	ICIN	±10	mA
Operating temperature range	T _{opr}	-40 to 85	°C
Storage temperature range	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Operating Ranges (V_{SS} = 0 V)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
DC supply voltage	V_{DD}	_	3	_	18	V
Input/Output voltage	V _{IN} /V _{OUT}	1	0	_	V_{DD}	V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused control inputs must be tied to either V_{DD} or V_{SS} .



Electrical Characteristics (V_{SS} = 0 V, unless specified otherwise)

Characteristics			Test Condition		-40°C		25°C			85°C		
		Symbol		V _{DD} (V)	Min	Max	Min	Тур.	Max	Min	Max	Unit
Control i high volt		V _{IH}	I _{IS} = 10 μΑ	5 10 15	3.5 7.0 11.0		3.5 7.0 11.0	2.75 5.50 8.25		3.5 7.0 11.0	_ _ _	>
Control i voltage	nput low	VIL	lis = 10 μA	5 10 15	_ _ _	1.5 3.0 4.0	_ _ _	2.25 4.50 6.75	1.5 3.0 4.0	_ _ _	1.5 3.0 4.0	٧
On-state resistance		Ron	$0 \le V_{IS} \le VDD$ RL = 10 k Ω	5 10 15	_ _ _	800 210 140	_ _ _	290 120 85	950 250 160	_ _ _	1200 300 200	Ω
ΔOn-state resistant (between switches	ce n any 2	RonΔ	_	5 10 15	_ _ _	_ _ _	_ _ _	10 6 4	_ _ _	_ _ _	_ _ _	Ω
Input/out leakage		IOFF	VIN = 18 V, VOUT = 0 V VIN = 0 V, VOUT = 18 V	18 18	_	±100 ±100	_	±0.1 ±0.1	±100 ±100	_	±1000 ±1000	nA
Quiesce supply c		I _{DD}	VIN = VSS, VDD (Note 1)	5 10 15	_ _ _	0.25 0.50 1.00	_ _ _	0.001 0.001 0.002	0.25 0.50 1.00	_ _ _	7.5 15.0 30.0	μА
Control Input	"H" level	lін	V _{IH} = 18 V	18	_	0.1	_	10 ⁻⁵	0.1	_	1.0	
current	"L" level	Ι _Ι L	VIL = 0 V	18		-0.1	_	-10 ⁻⁵	-0.1	_	-1.0 μA	μΑ

Note 1: All valid input combinations.



Switching Characteristics (Ta = 25°C)

		Test Condition				Min	Тур.	Max	Unit
Characteristics	Symbol	V _{SS} V _{DD} (V) (V)							
Phase difference between input to output	фI-O	C _L = 50 pF		0 0 0	5 10 15	_ _ _	15 8 5	40 20 15	ns
Propagation delay time (control-OUT)	^t pZL ^t pZH	$R_L = 1 \text{ k}\Omega$ $C_L = 50 \text{ pF}$		0 0 0	5 10 15	_ _ _	55 25 20	120 40 30	ns
Propagation delay time (control -OUT)	tpLZ tpHZ	R _L = 1 kΩ C _L = 50 pF		0 0 0	5 10 15	_ _ _	45 30 25	80 70 60	ns
Max control input repetition rate	f _{max} (C)	R _L = 1 kΩ C _L = 50 pF		0 0 0	5 10 15	_ _ _	10 12 12	_ _ _	MHz
-3dB cutoff frequency	f _{max} (I-O)	$R_L = 1 \text{ k}\Omega$ $C_L = 15 \text{ pF}$	(Note 1)	-5	5	_	30	_	MHz
Total harmonic distortion	_	R _L = 10 kΩ f = 1 kHz	(Note 2)	-5	5	_	0.03	_	%
-50dB feed through frequency	_	$R_L = 1 k\Omega$	(Note 3)	-5	5	_	600	_	kHz
-50dB crosstalk frequency	_	$R_L = 1 k\Omega$	(Note 4)	-5	5	_	1	_	MHz
Crosstalk (control-OUT)	_	$R_{IN} = 1 \text{ k}\Omega$ $R_{OUT} = 10 \text{ k}\Omega$ $C_L = 15 \text{ pF}$		0 0 0	5 10 15	_ _ _	200 400 600	_ _ _	mV
Input capacitance	CIN	Control input		1		_	5	7.5	pF
Feed through capacitance	CIN-OUT	Switch I/O	_				10 0.5	_	pF

Note 1: Sine wave of ±2.5 V_{p-p} shall be used for V_{IS} and the frequency of 20 log 10 $\frac{V_{OS}}{V_{IS}}$ = -3 dB shall be f_{max}.

Note 2: V_{IS} shall be sine wave of $\pm 2.5 V_{p-p}$

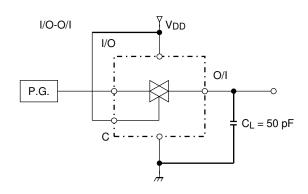
Note 3: Sine wave of $\pm 2.5 \text{ Vp-p}$ shall be used for V_{IS} and the frequency of 20 log 10 $\frac{V_{OS}}{V_{IS}}$ = -50 dB shall be feed-through.

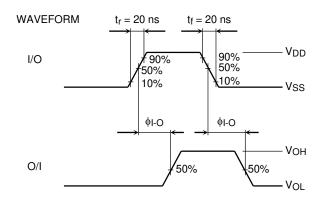
Note 4: Sine wave of ±2.5 Vp-p shall be used for Vis and the frequency of 20 log 10 $\frac{V_{OS}}{V_{IS}}$ = -50 dB shall be crosstalk.



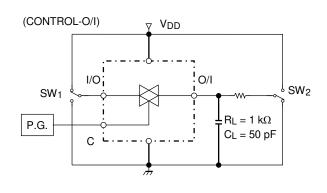
Circuit for Measurement of Electrical Characteristics

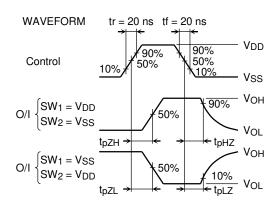
1. **\$\phi_{1}\cdot\text{0}**



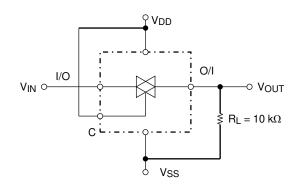


2. tpZL, tpZH, tpLZ, tpHZ





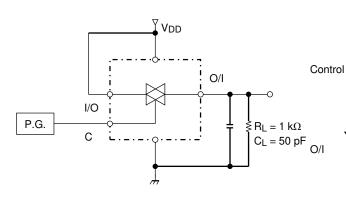
3. RON



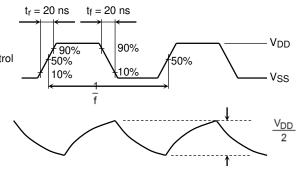
RON Calculation Method

$$R_{ON} = 10 \times \frac{(V_{IN} - V_{OUT})}{V_{OUT}} \left[k\Omega \right]$$

4. fmax (C)

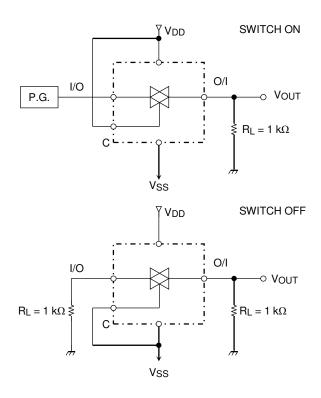


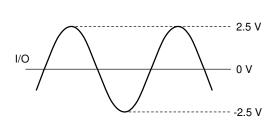
WAVEFORM



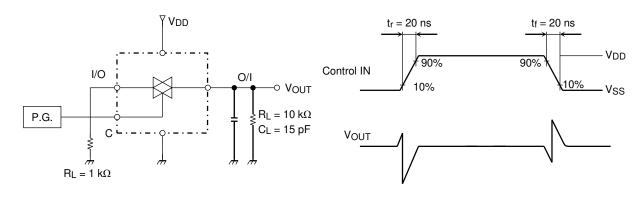


5. Crosstalk between Any Two Switches

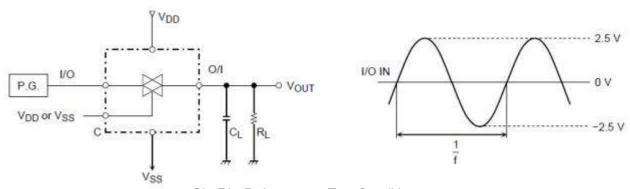




6. Crosstalk, Control to Input



7. Total Harmonic Distortion, fmax (I-O), Feedthrough (Switch OFF)

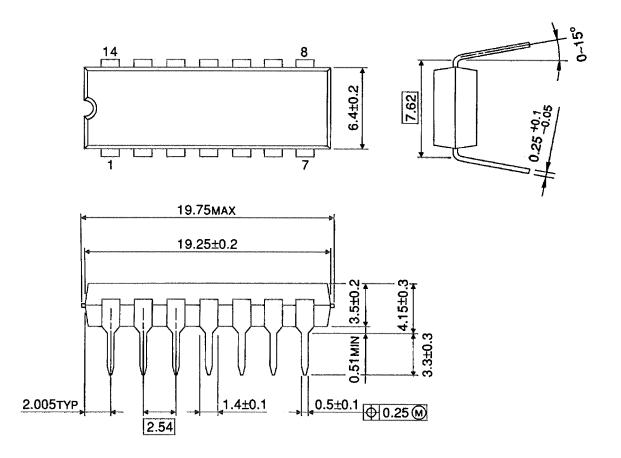


CL, RL: Reference to Test Condition



Package Dimensions

DIP14-P-300-2.54 Unit: mm

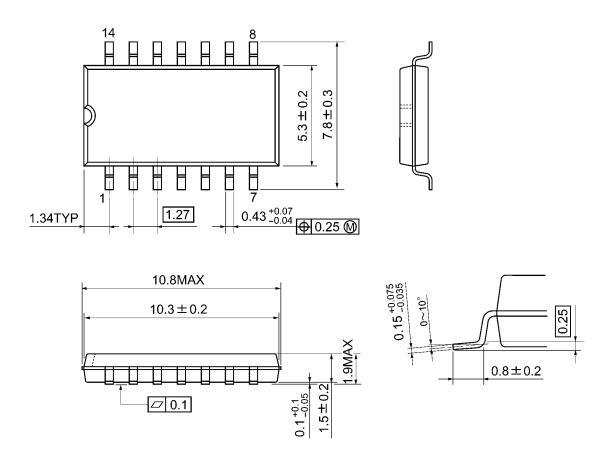


Weight: 0.96 g (typ.)



Package Dimensions

SOP14-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

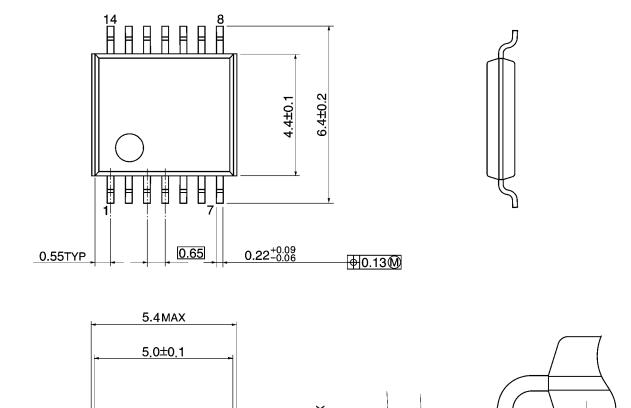
0.25



Package Dimensions

TSSOP14-P-0044-0.65A

Unit: mm



1.0±0.05

 0.1 ± 0.05

0~10

(0.5)

0.45~0.75

Weight: 0.06 g (typ.)

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